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# TND314S

## Excellent Power Device

Dual inverter driver for general purpose, Dual SOIC8

ON Semiconductor®

<http://onsemi.com>

### Features

- Dual inverter
- Withstand voltage of 25V is assured
- Peak output current : 1A
- Fully compatible input to TTL / CMOS ( $V_{IH}$ =up to 2.6V, at  $V_{DD}$ =4.5 to 25V)
- Built-in input pull-down resistance
- Monolithic structure (High voltage CMOS process adopted)
- Wide range of operating voltage : 4.5V to 25V
- Fast switching time (25ns typical at 1000pF load)
- Halogen free compliance

### Specifications

**Absolute Maximum Ratings** at  $T_a=25^\circ\text{C}$

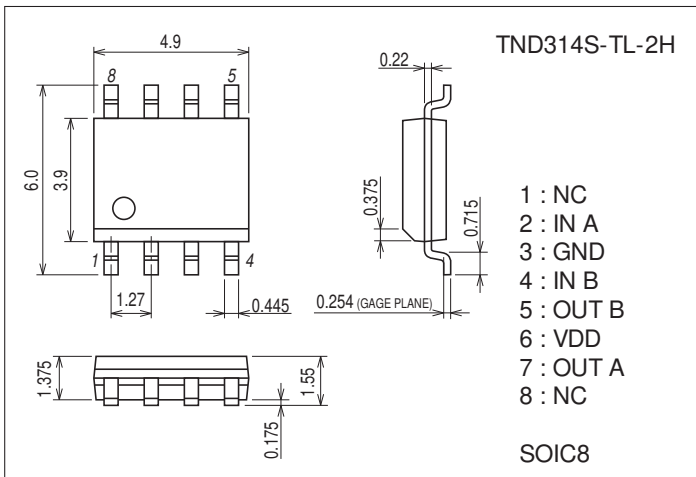
Parameter	Symbol	Conditions	Ratings	Unit
Supply Voltage	$V_{DD}$		0 to 25	V
Input Voltage	$V_{IN}$		GND-0.3 to $V_{DD}+0.3$	V
Allowable Power Dissipation	$P_D$ max		0.3	W
Junction Temperature	$T_J$		-55 to +150	$^\circ\text{C}$
Storage Temperature	$T_{stg}$		-55 to +150	$^\circ\text{C}$

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

### Package Dimensions

unit : mm (typ)

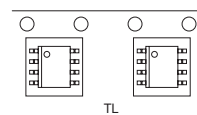
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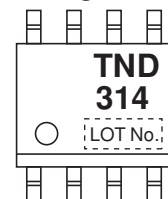
### Product & Package Information

- Package : SOIC8
- JEITA, JEDEC : SC-87, SOT-96
- Minimum Packing Quantity : 2,500 pcs./reel

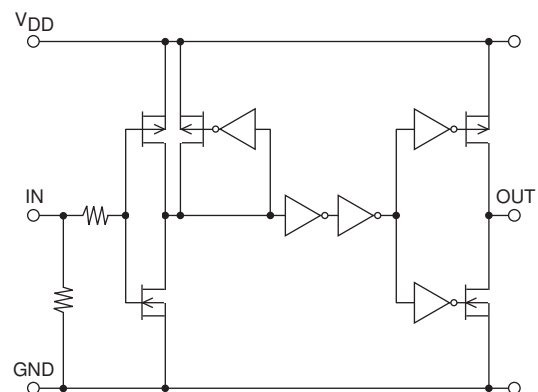
### Packing Type: TL



### Marking



### Block Diagram



# TND314S

## Recommend Operating Conditions at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Operating Supply Voltage	V <sub>DD</sub>		4.5 to 25	V
Operating Temperature	Topr		-40 to +125	°C

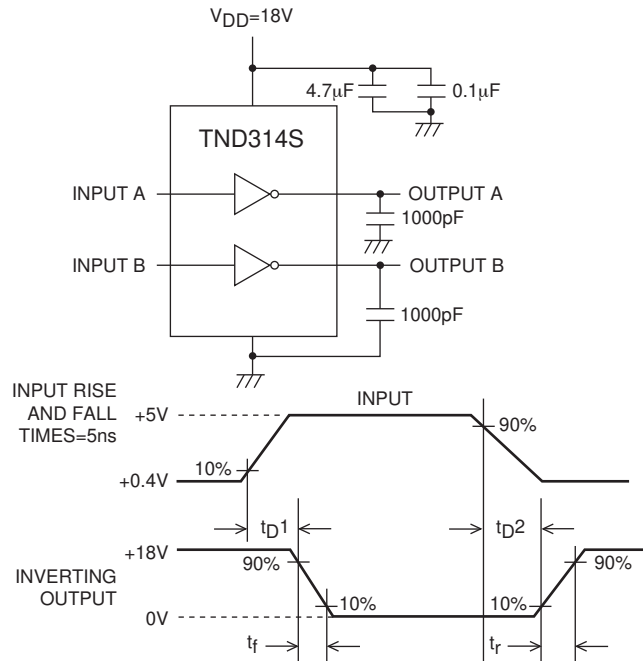
## Electrical Characteristics (AC Characteristics) at Ta=25°C, V<sub>DD</sub>=18V, V<sub>IN</sub>=5V

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Turn-On Rise Time	t <sub>r</sub>	C <sub>L</sub> =1000pF		30	45	ns
Turn-Off Fall Time	t <sub>f</sub>	C <sub>L</sub> =1000pF		30	45	ns
Delay Time	t <sub>D1</sub>	C <sub>L</sub> =1000pF		25	40	ns
	t <sub>D2</sub>	C <sub>L</sub> =1000pF		45	60	ns

## Electrical Characteristics (DC Characteristics) at Ta=25°C, V<sub>DD</sub>=4.5 to 25V

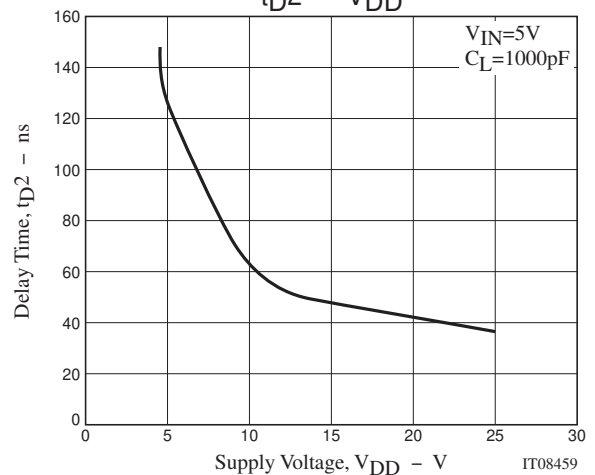
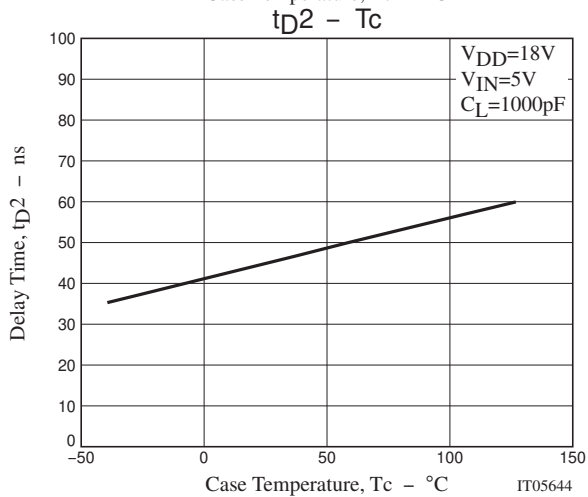
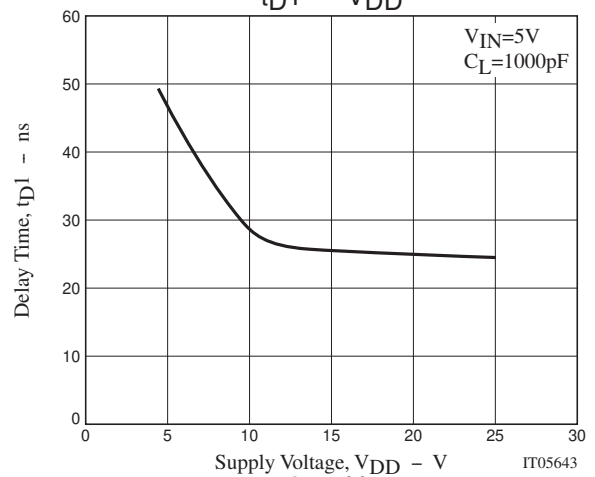
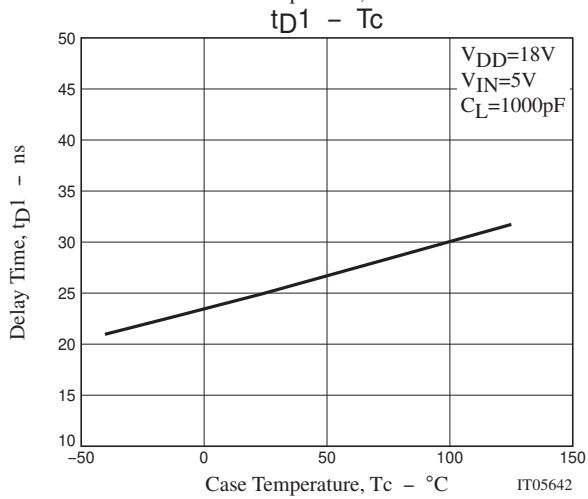
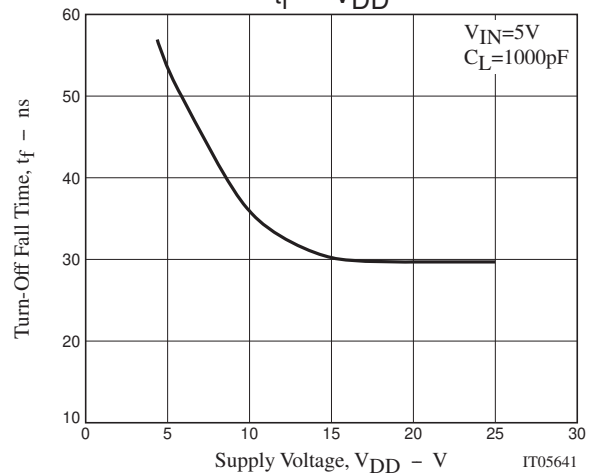
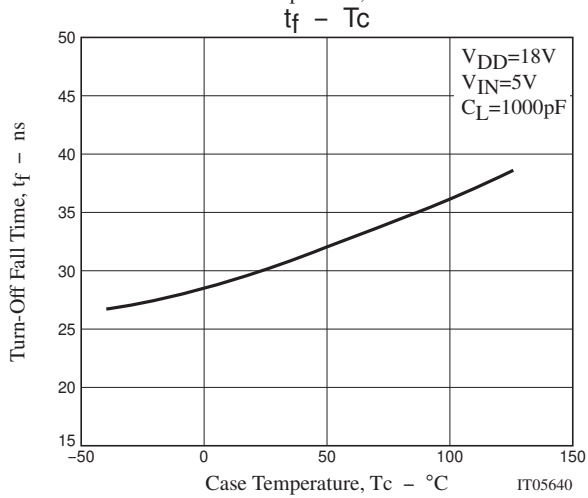
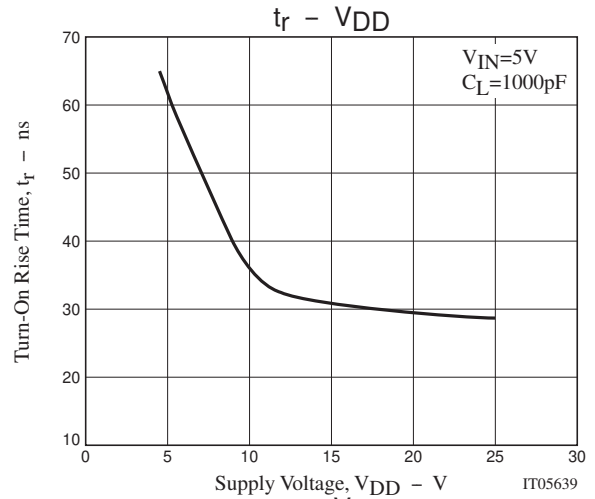
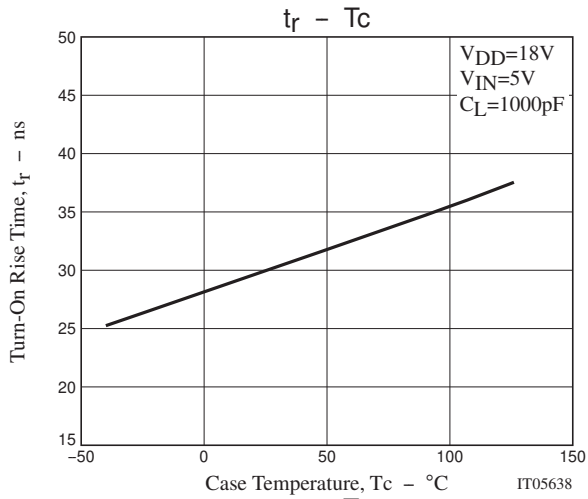
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Logic "1" Input Voltage	V <sub>IH</sub>		2.6			V
Logic "0" Input Voltage	V <sub>IL</sub>				0.8	V
Logic "1" Input Bias Current	I <sub>IN+</sub>	V <sub>IN</sub> =V <sub>DD</sub> =25V		40	100	μA
Logic "0" Input Bias Current	I <sub>IN-</sub>	V <sub>IN</sub> =0V or V <sub>DD</sub>	-1		1	μA
High-level Output Voltage	V <sub>OH</sub>	I <sub>O</sub> =0A	V <sub>DD</sub> -0.1			V
Low-level Output Voltage	V <sub>OL</sub>	I <sub>O</sub> =0A			0.1	V
V <sub>DD</sub> Supply Current	I <sub>supp</sub>	V <sub>DD</sub> =10V, V <sub>IN</sub> =3V, (both inputs)		1.0	4.5	mA
		V <sub>DD</sub> =10V, V <sub>IN</sub> =0V, (both inputs)			0.2	mA
Output High Short Circuit Pulsed Current	I <sub>O+</sub>	V <sub>DD</sub> =18V, PW≤10μs, V <sub>OUT</sub> =0V		1.0		A
Output Low Short Circuit Pulsed Current	I <sub>O-</sub>	V <sub>DD</sub> =18V, PW≤10μs, V <sub>OUT</sub> =18V		1.0		A
Output On Resistance	R <sub>OUT</sub>	V <sub>DD</sub> =18V, I <sub>load</sub> =10mA, V <sub>OUT</sub> ="H"		8	12	Ω
		V <sub>DD</sub> =18V, I <sub>load</sub> =10mA, V <sub>OUT</sub> ="L"		6	10	Ω

## Switching Time Test Circuit



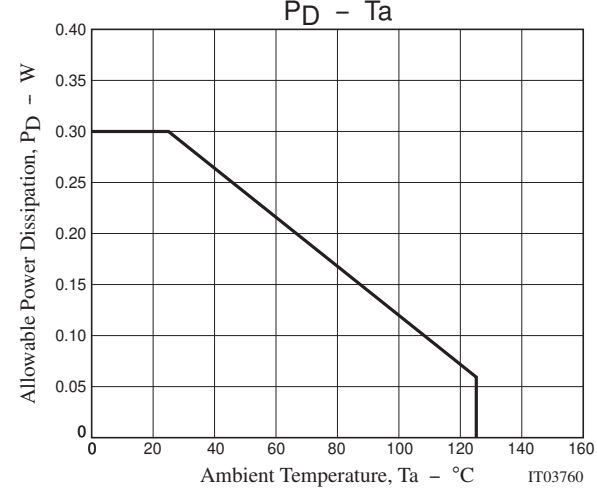
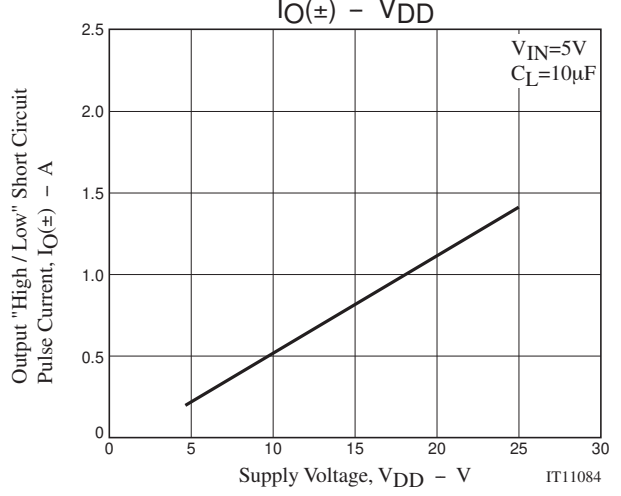
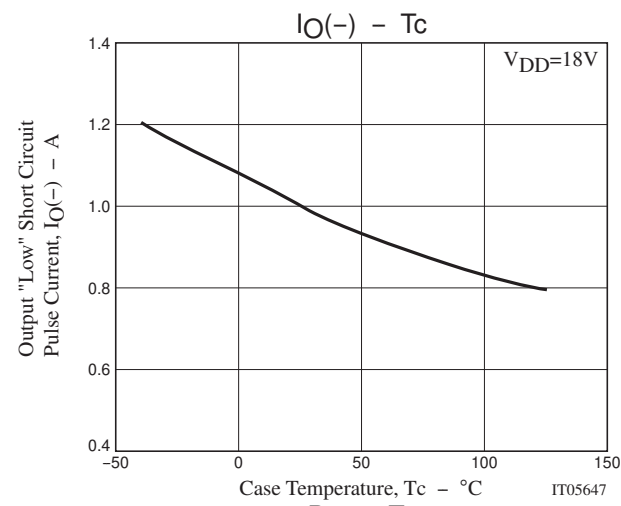
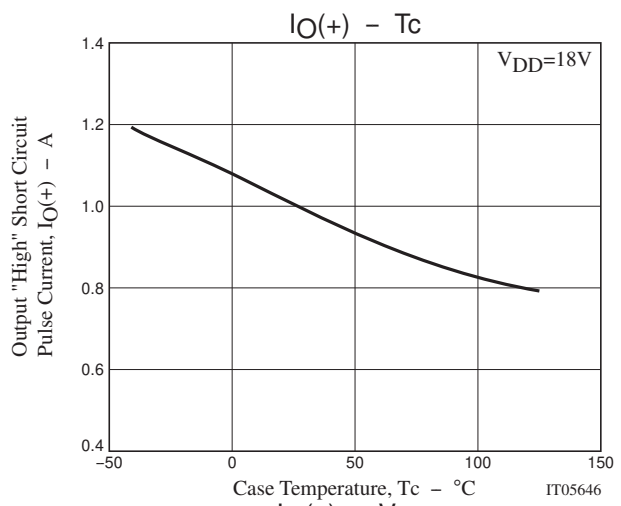
## Ordering Information

Devices	Package	Shipping	memo
TND314S-TL-2H	SOIC8	2,500pcs./reel	Pb Free and Halogen Free





TND314S



## Taping Specification

TND314S-TL-2H

### 1. Packing Format

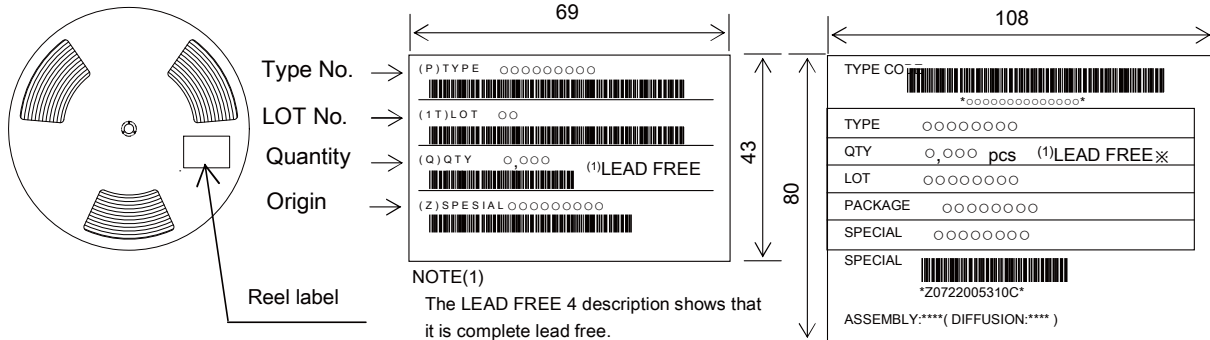
Package Name	Carrier Tape Type	Maximum Number of devices contained (pcs)			Packing format	
		Reel	Inner box	Outer box	Inner BOX W206-112	Outer BOX W207-124
SOIC8	B202-101	2,500	12,500	25,000	5 reels contained Dimensions :mm(external) 340×95×340	2 inner boxes contained Dimensions :mm(external) 360×210×375

#### Packing method

#### Reel label, Inner box label (unit: mm)

#### Outer box label

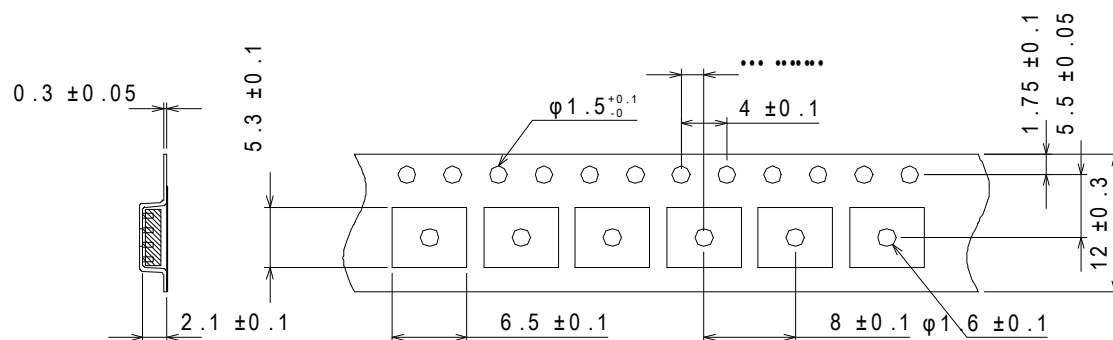
It is a label at the time of factory shipments.  
The form of a label may change in physical distribution process.



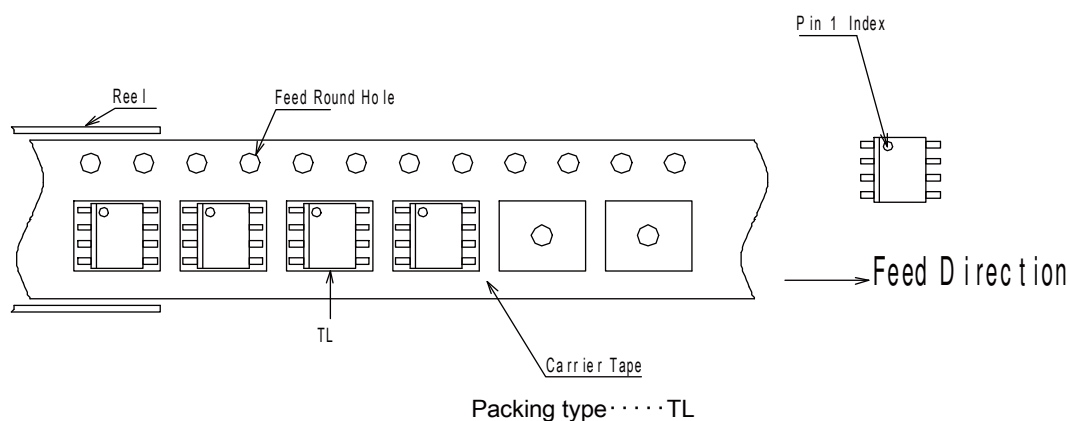
Label	JEITA Phase
LEAD FREE 4	JEITA Phase 3

## 2. Taping configuration

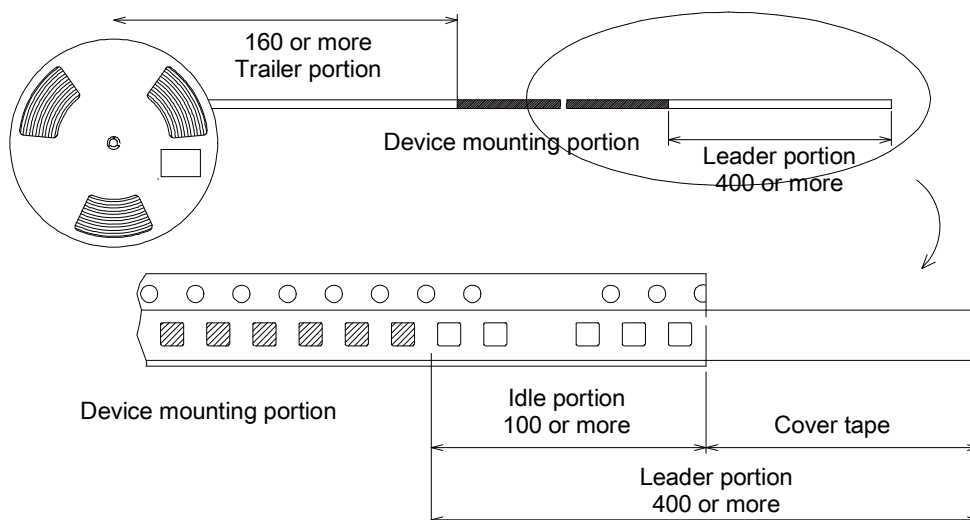
2-1. Carrier tape size (unit: mm)



## 2-2. Device placement direction



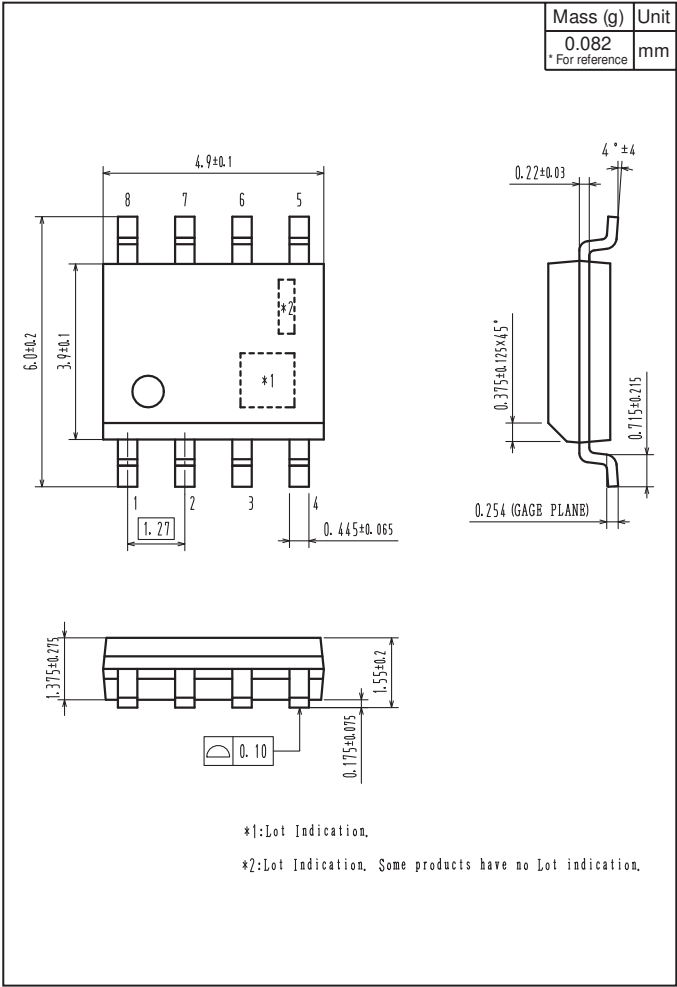
2-3. Leader portion and trailer portion (unit: mm )



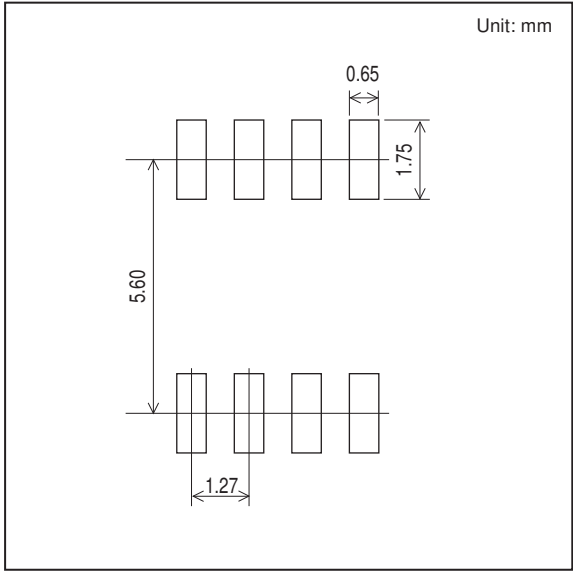
TND314S

Outline Drawing

TND314S-TL-2H



Land Pattern Example





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